

**PATENT**

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In re Application of:

MATTHIAS BONKA $\beta$   
AXEL PREUSSE  
MARKUS NOPPER

Serial No.: 10/629,106

Filed: July 29, 2003

For: METHOD OF PLATING A  
SEMICONDUCTOR STRUCTURE

Confirmation No.: 6373

Examiner: Luan V. Van

Group Art Unit: 1753

Att'y Docket: 2000.108300/DE0340

Customer No.: 23720

**RESPONSE TO OFFICE ACTION DATED MAY 8, 2006**

Mail Stop Amendment  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Sir:

This paper is submitted in response to the Office Action dated May 8, 2006, for which the three-month date for response is August 8, 2006.

No fees are believed to be due in connection with the present paper. However, should any fees be required under 37 C.F.R. §§ 1.16 to 1.21, the Director is authorized to deduct such fees from Williams, Morgan & Amerson, P.C. Deposit Account No. 50-0786/2000.108300.

Reconsideration of the application in view of the following amendments and remarks is respectfully requested.